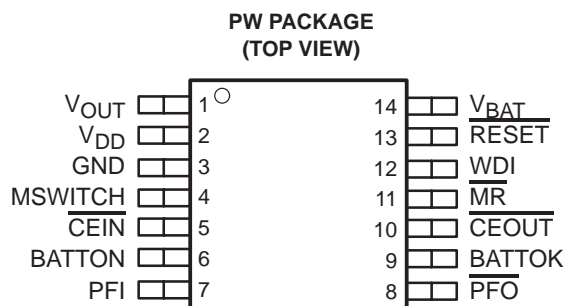


## features

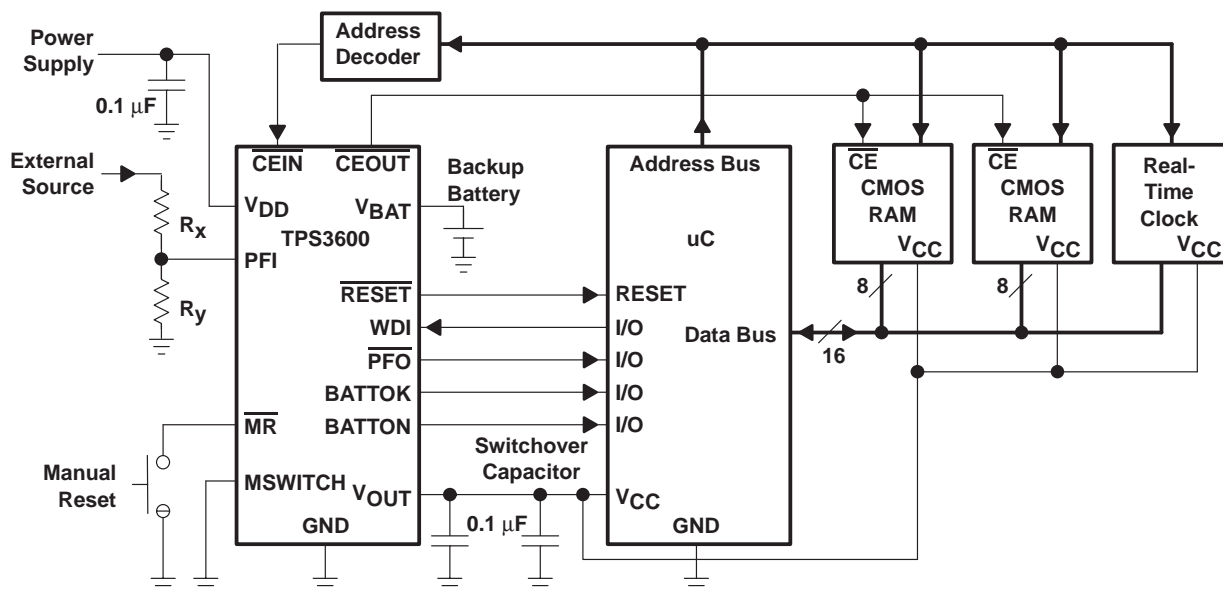
- Supply Current of 40  $\mu\text{A}$  (Max)
- Precision Supply Voltage Monitor
  - 2.0 V, 3.3 V, 5.0 V
  - Other Versions on Request
- Watchdog Timer With 800-ms Time-Out
- Backup-Battery Voltage Can Exceed  $V_{DD}$
- Power-On Reset Generator With Fixed 100-ms Reset Delay Time
- Battery OK Output
- Voltage Monitor for Power-Fail or Low-Battery Monitoring
- Manual Switchover to Battery-Backup Mode
- Chip-Enable Gating –3 ns (at  $V_{DD} = 5\text{ V}$ )  
Max. Propagation Delay
- Manual Reset
- Battery Freshness Seal
- 14-Pin TSSOP Package
- Temperature Range . . .  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$

## typical applications

- Fax Machines
- Set-Top Boxes
- Advanced Voice Mail Systems
- Portable Battery Powered Equipment
- Computer Equipment
- Advanced Modems
- Automotive Systems
- Portable Long-Time Monitoring Equipment
- Point of Sale Equipment



## typical operating circuit



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

SLVS336 – DECEMBER 2000

## description

The TPS3600 family of supervisory circuits monitor and control processor activity. In case of power-fail or brownout conditions, the backup-battery switchover function of TPS3600 allows to run a low-power processor and its peripherals from the installed backup battery without asserting a reset beforehand.

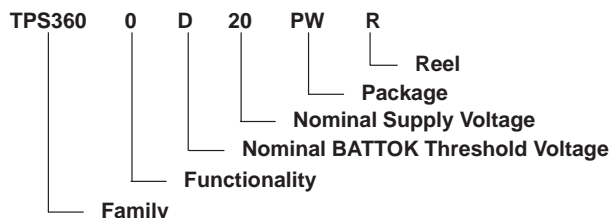
During power on,  $\overline{\text{RESET}}$  is asserted when the supply voltage ( $V_{\text{DD}}$  or  $V_{\text{BAT}}$ ) becomes higher than 1.1 V. Thereafter, the supply voltage supervisor monitors  $V_{\text{OUT}}$  and keeps  $\overline{\text{RESET}}$  output active as long as  $V_{\text{OUT}}$  remains below the threshold voltage ( $V_{\text{IT}}$ ). An internal timer delays the return of the output to the inactive state (high) to ensure proper system reset. This delay timer starts its time-out, after  $V_{\text{OUT}}$  has risen above the threshold voltage ( $V_{\text{IT}}$ ). In case of a brownout or power failure of both supply sources, a voltage drop below the threshold voltage ( $V_{\text{IT}}$ ) get detected and the output becomes active (low) again.

The product spectrum is designed for supply voltages of 2 V, 3.3 V, and 5 V. The circuits are available in a 14-pin TSSOP package. The TPS3600 devices are characterized for operation over a temperature range of  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

PACKAGE INFORMATION

| $T_{\text{A}}$                                | DEVICE NAME |
|---|-------------|
| $-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$ | TPS3600D20  |
|   | TPS3600D33  |
|   | TPS3600D50  |

## ordering information application specific versions (see Note)



| DEVICE NAME                | NOMINAL VOLTAGE, $V_{\text{NOM}}$ |
|----------------------------|-----------------------------------|
| TPS3600x20 PW              | 2.0 V                             |
| TPS3600x25 PW <sup>†</sup> | 2.5 V                             |
| TPS3600x30 PW <sup>†</sup> | 3.0 V                             |
| TPS3600x33 PW              | 3.3 V                             |
| TPS3600x50 PW              | 5.0 V                             |

| DEVICE NAME                | NOMINAL BATTOK<br>THRESHOLD VOLTAGE, $V_{\text{BOK}}$ |
|----------------------------|---|
| TPS3600Dxx PW              | $V_{\text{IT}} + 7\%$                                 |
| TPS3600Fxx PW <sup>†</sup> | $V_{\text{IT}} + 6\%$                                 |
| TPS3600Hxx PW <sup>†</sup> | $V_{\text{IT}} + 8\%$                                 |
| TPS3600Jxx PW <sup>†</sup> | $V_{\text{IT}} + 10\%$                                |

<sup>†</sup> For the application specific versions, please contact the local TI sales office for availability and lead time.



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# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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FUNCTION TABLES

| $V_{DD} > V_{SW}$ | $V_{OUT} > V_{IT}$ | $V_{DD} > V_{BAT}$ | MSWITCH | $\overline{MR}$ | $V_{OUT}$ | BATTON | $\overline{RESET}$ | $\overline{CEOUT}$ |
|-------------------|--------------------|--------------------|---------|-----------------|-----------|--------|--------------------|--------------------|
| 0                 | 0                  | 0                  | 0       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 0                  | 0                  | 0       | 1               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 0                  | 0                  | 1       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 0                  | 0                  | 1       | 1               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 0                  | 1                  | 0       | 0               | $V_{DD}$  | 0      | 0                  | DIS                |
| 0                 | 0                  | 1                  | 0       | 1               | $V_{DD}$  | 0      | 0                  | DIS                |
| 0                 | 0                  | 1                  | 1       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 0                  | 1                  | 1       | 1               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 1                  | 0                  | 0       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 1                  | 0                  | 0       | 1               | $V_{BAT}$ | 1      | 1                  | EN                 |
| 0                 | 1                  | 0                  | 1       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 1                  | 0                  | 1       | 1               | $V_{BAT}$ | 1      | 1                  | EN                 |
| 0                 | 1                  | 1                  | 0       | 0               | $V_{DD}$  | 0      | 0                  | DIS                |
| 0                 | 1                  | 1                  | 0       | 1               | $V_{DD}$  | 0      | 1                  | EN                 |
| 0                 | 1                  | 1                  | 1       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 1                  | 1                  | 1       | 1               | $V_{BAT}$ | 1      | 1                  | EN                 |
| 0                 | 1                  | 0                  | 0       | 0               | $V_{DD}$  | 0      | 0                  | DIS                |
| 0                 | 1                  | 0                  | 0       | 1               | $V_{DD}$  | 0      | 1                  | EN                 |
| 0                 | 1                  | 0                  | 1       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 0                 | 1                  | 0                  | 1       | 1               | $V_{BAT}$ | 1      | 1                  | EN                 |
| 0                 | 1                  | 1                  | 0       | 0               | $V_{DD}$  | 0      | 0                  | DIS                |
| 0                 | 1                  | 1                  | 0       | 1               | $V_{DD}$  | 0      | 1                  | EN                 |
| 1                 | 1                  | 1                  | 1       | 0               | $V_{BAT}$ | 1      | 0                  | DIS                |
| 1                 | 1                  | 1                  | 1       | 1               | $V_{BAT}$ | 1      | 1                  | EN                 |

| $V_{BAT} > V_{BOK}$ | BATTOK |
|---------------------|--------|
| 0                   | 0      |
| 1                   | 1      |

CONDITION:  $V_{OUT} > V_{DD(min)}$

| $\overline{CEIN}$ | $\overline{CEOUT}$ |
|-------------------|--------------------|
| 0                 | 0                  |
| 1                 | 1                  |

CONDITION: Enabled

| $PFI > V_{PFI}$ | $\overline{PFO}$ |
|-----------------|------------------|
| 0               | 0                |
| 1               | 1                |

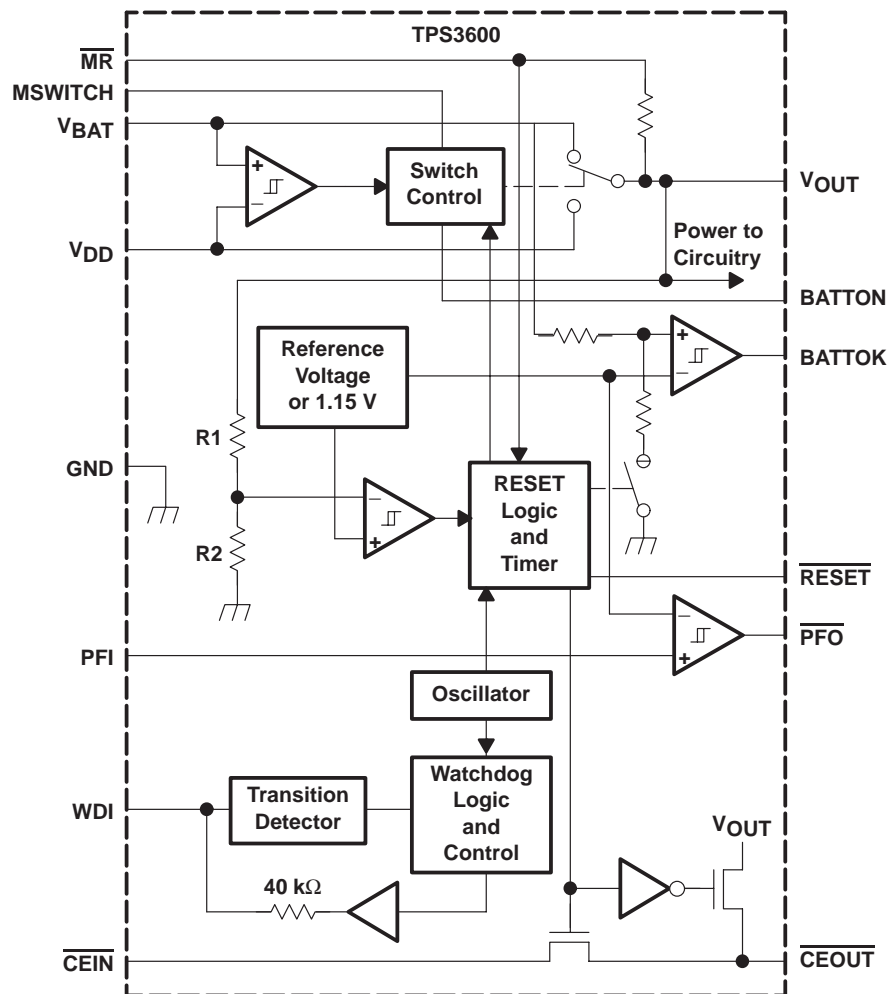
CONDITION:  $V_{OUT} > V_{DD(min)}$



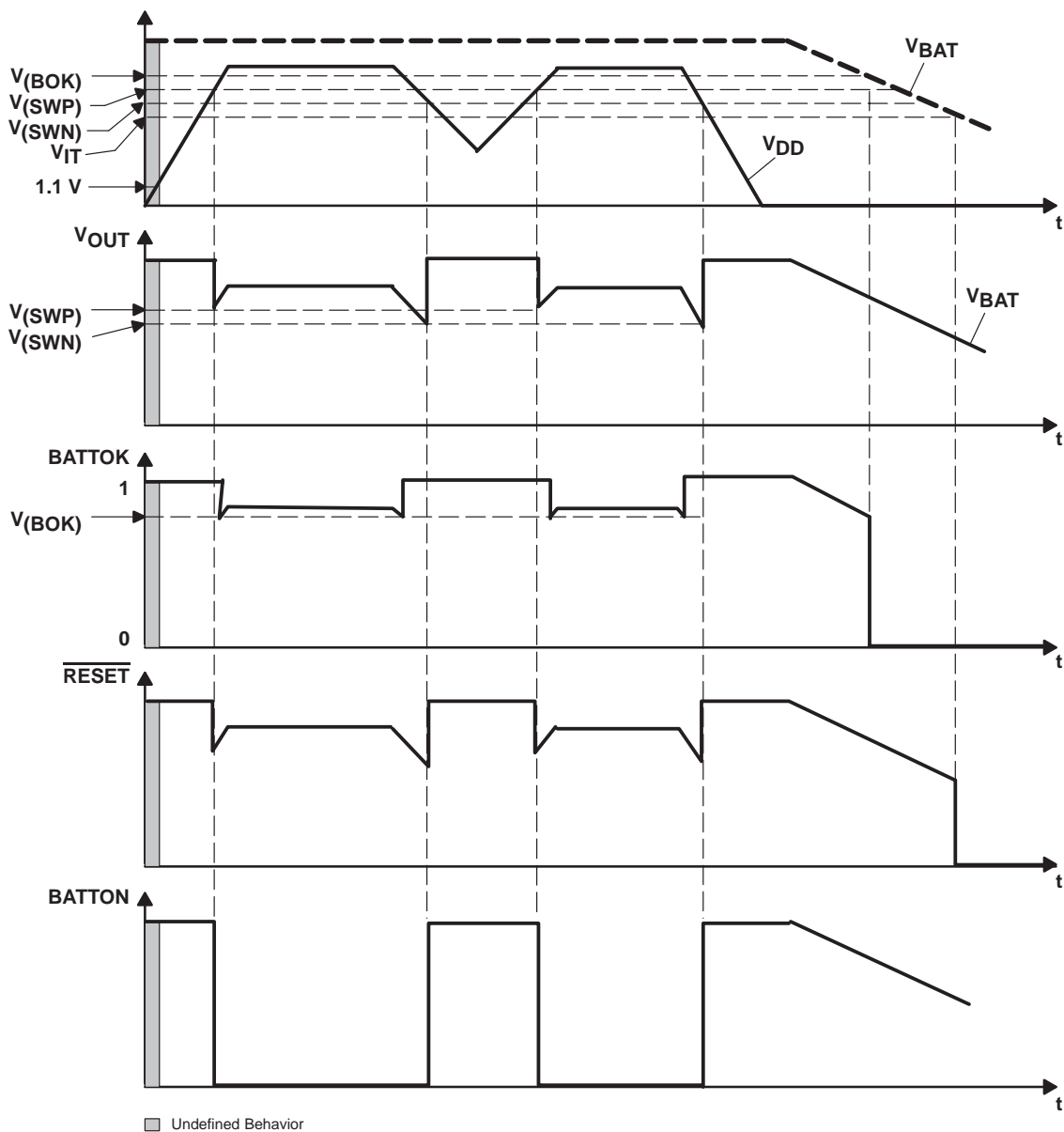
# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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## functional schematic



timing diagram



NOTES: A.  $MSSWITCH = 0$ ,  $\overline{MR} = 1$   
B. Timing diagram shown under normal operation, not in freshness seal mode.

# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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## Terminal Functions

| TERMINAL<br>NAME          | NO. | I/O | DESCRIPTION  |
|---------------------------|-----|-----|--|
| BATTOK                    | 9   | O   | Battery status output                                  |
| BATTON                    | 6   | O   | Logic output/external bypass switch driver output      |
| $\overline{\text{CEIN}}$  | 5   | I   | Chip-enable input                                      |
| $\overline{\text{CEOUT}}$ | 10  | O   | Chip-enable output                                     |
| GND                       | 3   | I   | Ground   |
| $\overline{\text{MR}}$    | 11  | I   | Manual reset input                                     |
| MSWITCH                   | 4   | I   | Manual switch to force device into battery-backup mode |
| PFI                       | 7   | I   | Power-fail comparator input                            |
| $\overline{\text{PFO}}$   | 8   | O   | Power-fail comparator output                           |
| $\overline{\text{RESET}}$ | 13  | O   | Active-low reset output                                |
| V <sub>BAT</sub>          | 14  | I   | Backup-battery input                                   |
| V <sub>DD</sub>           | 2   | I   | Input supply voltage                                   |
| V <sub>OUT</sub>          | 1   | O   | Supply output  |
| WDI                       | 12  | I   | Watchdog timer input                                   |

## detailed description

### battery freshness seal

The battery freshness seal of the TPS3600 family disconnects the backup battery from the internal circuitry until it is needed. This ensures that the backup battery connected to V<sub>BAT</sub> should be fresh when the final product is put to use. The following steps explain how to enable the freshness seal mode:

1. Connect V<sub>BAT</sub> (V<sub>BAT</sub> > V<sub>BAT(min)</sub> or V<sub>DD(min)</sub>)
2. Ground  $\overline{\text{PFO}}$
3. Connect PFI to V<sub>DD</sub> (PFI = V<sub>DD</sub>)
4. Connect V<sub>DD</sub> to power supply (V<sub>DD</sub> > V<sub>IT</sub>) and keep connected for 5 ms < t < 35 ms

The battery freshness seal mode is disabled by the positive-going edge of  $\overline{\text{RESET}}$  when V<sub>DD</sub> is applied.

### BATTOK output

This is a logic feedback of the device to indicate the status of the backup battery. The supervisor checks the battery voltage every 200 ms with a voltage divider load of approximately 100 K $\Omega$  and a measure cycle on-time of 25  $\mu$ s. This measurement cycle starts after the reset is released. If the battery voltage V<sub>BATT</sub> is below the negative-going threshold voltage V<sub>BOK</sub>, the indicator BATTOK does a high-to-low transition. Otherwise, its status remains to the V<sub>OUT</sub> level.

Table 1. Typical Values for BATTOK Indication

| SUPERVISOR TYPE | V <sub>IT</sub> TYP | V <sub>BOK</sub> MIN | V <sub>BOK</sub> TYP | V <sub>BOK</sub> MAX |
|-----------------|---------------------|----------------------|----------------------|----------------------|
| TPS3600x20      | 1.78 V              | 1.84 V               | 1.91 V               | 1.97 V               |
| TPS3600x33      | 2.93 V              | 3.04 V               | 3.14 V               | 3.24 V               |
| TPS3600x50      | 4.40 V              | 4.56 V               | 4.71 V               | 4.86 V               |



## detailed description (continued)

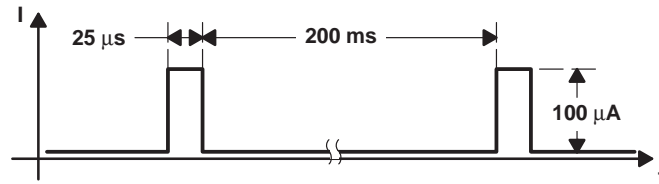


Figure 1. BATTOK Timing

## chip-enable signal gating

The internal gating of chip-enable (CE) signals prevents erroneous data from corrupting CMOS RAM during an under-voltage condition. The TPS3600 use a series transmission gate from  $\overline{\text{CEIN}}$  to  $\overline{\text{CEOUT}}$ . During normal operation (reset not asserted), the CE transmission gate is enabled and passes all CE transitions. When reset is asserted, this path becomes disabled, preventing erroneous data from corrupting the CMOS RAM. The short CE propagation delay from  $\overline{\text{CEIN}}$  to  $\overline{\text{CEOUT}}$  enables the TPS3600 devices to be used with most processors.

The CE transmission gate is disabled and  $\overline{\text{CEIN}}$  is high impedance (disable mode) while reset is asserted. During a power-down sequence when  $V_{DD}$  crosses the reset threshold, the CE transmission gate will be disabled and  $\overline{\text{CEIN}}$  immediately becomes high impedance if the voltage at  $\overline{\text{CEIN}}$  is high. If  $\overline{\text{CEIN}}$  is low during reset is asserted, the CE transmission gate will be disabled same time when  $\overline{\text{CEIN}}$  goes high, or 10  $\mu\text{s}$  after reset asserts, whichever occurs first. This will allow the current write cycle to complete during power down. When the CE transmission gate is enabled, the impedance of  $\overline{\text{CEIN}}$  appears as a 50- $\Omega$  resistor in series with the load at  $\overline{\text{CEOUT}}$ . To achieve minimum propagation delay, the capacitive load at  $\overline{\text{CEOUT}}$  should be minimized, and a low-output-impedance driver be used.

During disable mode, the transmission gate is off and an active pullup connects  $\overline{\text{CEOUT}}$  to  $V_{OUT}$ . This pullup turns off when the transmission gate is enabled.

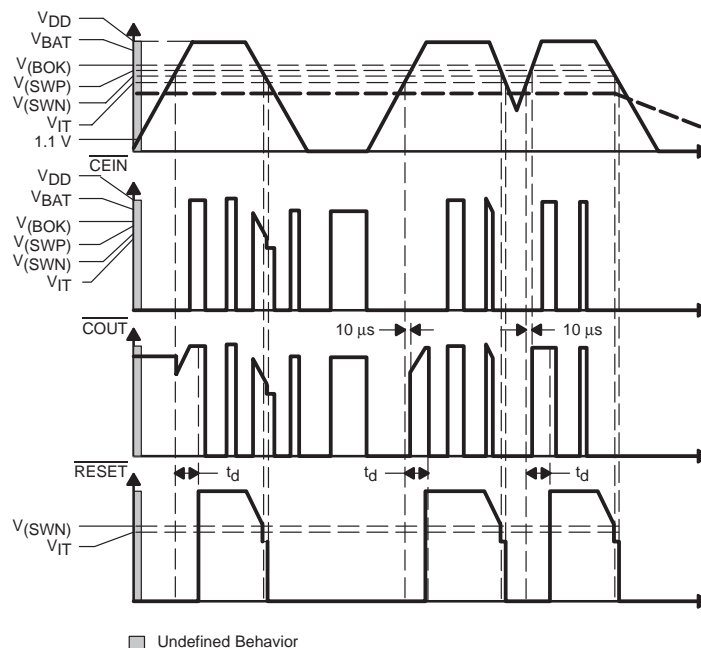
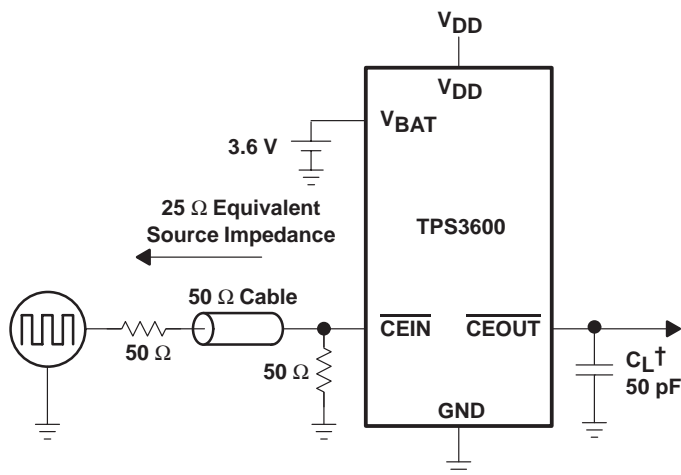


Figure 2. Chip-Enable Timing

# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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## detailed description (continued)



$^\dagger C_L$  Includes load capacitance and scope probe capacitance.

**Figure 3. CE Propagation Delay Test Circuit**

### power-fail comparator (PFI and $\overline{\text{PFO}}$ )

An additional comparator is provided to monitor voltages other than the nominal supply voltage. The power-fail input (PFI) will be compared with an internal voltage reference of 1.15 V. If the input voltage falls below the power-fail threshold ( $V_{\text{PFI}}$ ) of 1.15 V typical, the power-fail output ( $\overline{\text{PFO}}$ ) goes low. If it goes above 1.15 V plus about 20-mV hysteresis, the output returns to high. By connecting two external resistors, it is possible to supervise any voltages above 1.15 V. The sum of both resistors should be about 1 MΩ, to minimize power consumption and also to ensure that the current in the PFI pin can be neglected compared with the current through the resistor network. The tolerance of the external resistors should be not more than 1% to ensure minimal variation of sensed voltage.

If the power-fail comparator is unused, connect PFI to ground and leave  $\overline{\text{PFO}}$  unconnected.

### BATTON

Most often BATTON is used as a gate or base drive for an external pass transistor for high-current applications. In addition it can be also used as a logic output to indicate the battery switchover status. BATTON is high when  $V_{\text{OUT}}$  is connected to  $V_{\text{BAT}}$ .

BATTON can be directly connected to the base of a PNP transistor (see Figure 4a) or the gate of a PMOS transistor (see Figure 4b). No current-limiting resistor is required, but a resistor connecting the base of the PNP to BATTON can be used to limit the current drawn from  $V_{\text{DD}}$ , prolonging battery life in portable equipment. If you are using a PMOS transistor, however, it must be connected backwards from the traditional method (see Figure 4b). This method orients the body diode from  $V_{\text{DD}}$  to  $V_{\text{OUT}}$  and prevents the backup battery from discharging through the FET when its gate is high.



detailed description (continued)

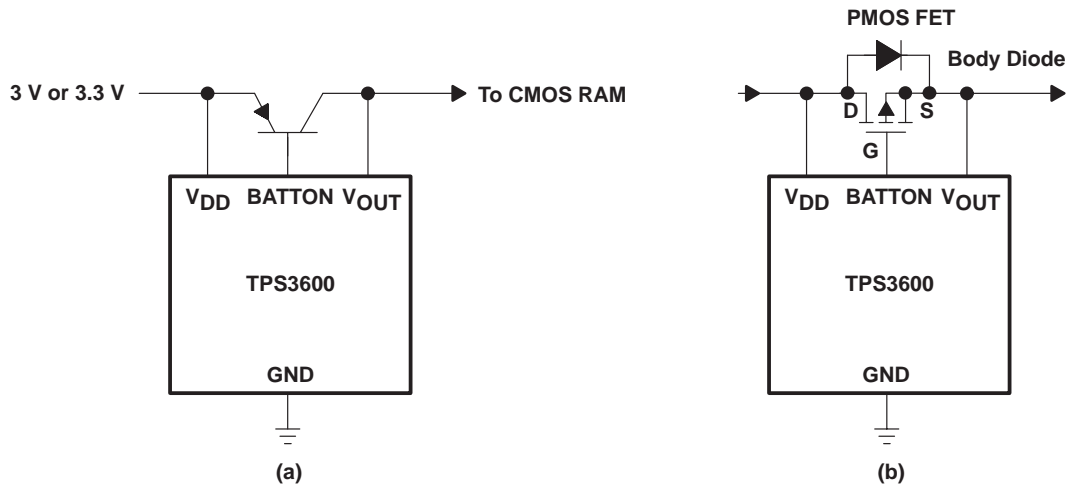


Figure 4. Driving an External Transistor With BATTON

backup-battery switchover

In the event of a brownout or power failure, it may be necessary to keep a processor running. If a backup battery is installed at  $V_{BAT}$ , the devices automatically connect the processor to backup power when  $V_{DD}$  fails. In order to allow the backup battery (e.g., a 3.6-V lithium cell) to have a higher voltage than  $V_{DD}$ , this family of supervisors will not connect  $V_{BAT}$  to  $V_{OUT}$  when  $V_{BAT}$  is greater than  $V_{DD}$ .  $V_{BAT}$  only connects to  $V_{OUT}$  (through a 2- $\Omega$  switch) when  $V_{OUT}$  falls below  $V_{IT}$  and  $V_{BAT}$  is greater than  $V_{DD}$ . When  $V_{DD}$  recovers, switchover is deferred either until  $V_{DD}$  crosses  $V_{BAT}$ , or when  $V_{DD}$  rises above the threshold ( $V_{SWP}$ ).  $V_{OUT}$  will connect to  $V_{DD}$  through a 2- $\Omega$  (max) PMOS power switch when  $V_{DD}$  crosses the reset threshold.

| $V_{DD} > V_{BAT}$ | $V_{DD} > V_{SW}$ | $V_{OUT}$ |
|--------------------|-------------------|-----------|
| 1                  | 1                 | $V_{DD}$  |
| 1                  | 0                 | $V_{DD}$  |
| 0                  | 1                 | $V_{DD}$  |
| 0                  | 0                 | $V_{BAT}$ |

manual switchover (MSWITCH)

While operating in the normal mode from  $V_{DD}$ , the device can be manually forced to operate in the battery-backup mode by connecting MSWITCH to  $V_{DD}$ . The table below shows the different switchover modes.

|                                 | MSWITCH  | STATUS                        |
|---------------------------------|----------|-------------------------------|
| <b><math>V_{DD}</math> mode</b> | GND      | $V_{DD}$ mode                 |
|                                 | $V_{DD}$ | Switch to battery-backup mode |
| <b>Battery-backup mode</b>      | GND      | Battery-backup mode           |
|                                 | $V_{DD}$ | Battery-backup mode           |

If the manual switchover feature is not used, MSWITCH must be connected to ground.

# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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## detailed description (continued)

### watchdog

In a microprocessor- or DSP-based system, it is not only important to supervise the supply voltage, it is also important to ensure the correct program execution. The task of a watchdog is to ensure that the program is not stalled in an indefinite loop. The microprocessor, microcontroller, or the DSP have to toggle the watchdog input within typically 0.8 s to avoid a time-out from occurring. Either a low-to-high or a high-to-low transition resets the internal watchdog timer. If the input is unconnected the watchdog is disabled and will be retriggered internally.

### saving current while using the watchdog

The watchdog input is internally driven low during the first 7/8 of the watchdog time-out period, then momentarily pulses high, resetting the watchdog counter. For minimum watchdog input current (minimum overall power consumption), leave WDI low for the majority of the watchdog time-out period, pulsing it low-high-low once within 7/8 of the watchdog time-out period to reset the watchdog timer. If instead, WDI is externally driven high for the majority of the time-out period, a current of e.g.  $5\text{ V}/40\text{ k}\Omega \approx 125\text{ }\mu\text{A}$  can flow into WDI.

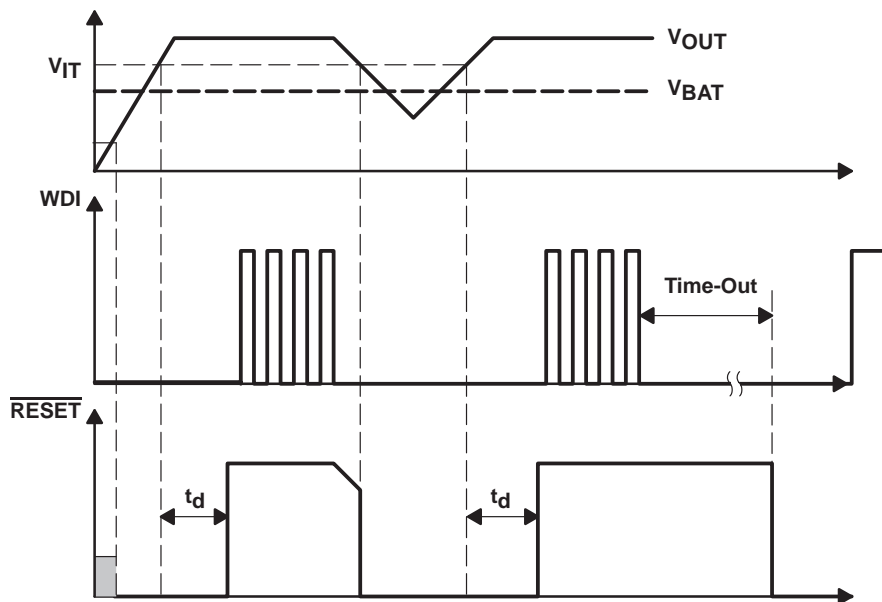


Figure 5. Watchdog Timing

# TPS3600D20, TPS3600D33, TPS3600D50 BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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## absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>

|  |                              |
|--|------------------------------|
| Supply voltage: $V_{DD}$ (see Note1)                                   | 7 V                          |
| All other pins (see Note 1)  | –0.3 V to 7 V                |
| Continuous output current at $V_{OUT}$ : $I_O$                         | 300 mA                       |
| All other pins, $I_O$  | ±10 mA                       |
| Continuous total power dissipation                                     | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$                            | –40°C to 85°C                |
| Storage temperature range, $T_{stg}$                                   | –65°C to 150°C               |
| Lead temperature soldering 1,6 mm (1/16 inch) from case for 10 seconds | 260°C                        |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND. For reliable operation the device must not be operated at 7 V for more than  $t = 1000h$  continuously.

**DISSIPATION RATING TABLE**

| PACKAGE | $T_A < 25^\circ\text{C}$<br>POWER RATING | DERATING FACTOR<br>ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 70^\circ\text{C}$<br>POWER RATING | $T_A = 85^\circ\text{C}$<br>POWER RATING |
|---------|--|---|--|--|
| PW      | 700 mW                                   | 5.6 mW/°C   | 448 mW                                   | 364 mW                                   |

## recommended operating conditions at specified temperature range

|  | MIN              | MAX              | UNIT  |
|--|------------------|------------------|-------|
| Supply voltage, $V_{DD}$   | 1.65             | 5.5              | V     |
| Battery supply voltage, $V_{BAT}$  | 1.5              | 5.5              | V     |
| Input voltage, $V_I$   | 0                | $V_O + 0.3$      | V     |
| High-level input voltage, $V_{IH}$                                       | $0.7 \times V_O$ |                  | V     |
| Low-level input voltage, all other pins, $V_{IL}$                        |                  | $0.3 \times V_O$ | V     |
| Continuous output current at $V_O$ , $I_O$                               |                  | 200              | mA    |
| Input transition rise and fall rate at WDI, MSWITCH, $\Delta t/\Delta V$ |                  | 100              | ns/V  |
| Slew rate at $V_{DD}$ or $V_{BAT}$                                       |                  | 34               | mV/μs |
| Operating free-air temperature range, $T_A$                              | –40              | 85               | °C    |



# TPS3600D20, TPS3600D33, TPS3600D50

## BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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### electrical characteristics over recommended operating conditions (unless otherwise noted)

| PARAMETER  |  |   | TEST CONDITIONS                                   | MIN                       | TYP                    | MAX                    | UNIT |
|--|--|---|---|---------------------------|------------------------|------------------------|------|
| V <sub>OH</sub>                                      | High-level output voltage                                      | RESET   | V <sub>O</sub> = 2.0 V, I <sub>OH</sub> = −400 μA | V <sub>OUT</sub> − 0.2 V  |                        |                        | V    |
|  |  | BATTOK  | V <sub>O</sub> = 3.3 V, I <sub>OH</sub> = −2 mA   | V <sub>OUT</sub> − 0.4 V  |                        |                        |      |
|  |  | BATTON  | V <sub>O</sub> = 5.0 V, I <sub>OH</sub> = −3 mA   |                           |                        |                        |      |
|  |  | PFO   | V <sub>O</sub> = 1.8 V, I <sub>OH</sub> = −20 μA  | V <sub>OUT</sub> − 0.3 V  |                        |                        |      |
|  |  |   | V <sub>O</sub> = 3.3 V, I <sub>OH</sub> = −80 μA  | V <sub>OUT</sub> − 0.4 V  |                        |                        |      |
|  |  |   | V <sub>O</sub> = 5.0 V, I <sub>OH</sub> = −120 μA |                           |                        |                        |      |
|  | CEOUT  | V <sub>O</sub> = 2.0 V, I <sub>OH</sub> = −1 mA                                 | V <sub>OUT</sub> − 0.2 V                          |                           |                        |                        |      |
|  | Enable mode  | V <sub>O</sub> = 3.3 V, I <sub>OH</sub> = −2 mA                                 | V <sub>OUT</sub> − 0.3 V                          |                           |                        |                        |      |
|  | CEIN = V <sub>OUT</sub>  | V <sub>O</sub> = 5.0 V, I <sub>OH</sub> = −5 mA                                 |   |                           |                        |                        |      |
|  | CEOUT  | V <sub>O</sub> = 3.3 V, I <sub>OH</sub> = −0.5 mA                               | V <sub>OUT</sub> − 0.4 V                          |                           |                        |                        |      |
|  | Disable mode   |   |   |                           |                        |                        |      |
| V <sub>OL</sub>                                      | Low-level output voltage                                       | RESET   | V <sub>O</sub> = 2.0 V, I <sub>OL</sub> = 400 μA  | 0.2                       |                        |                        | V    |
|  |  | PFO   | V <sub>O</sub> = 3.3 V, I <sub>OL</sub> = 2 mA    | 0.4                       |                        |                        |      |
|  |  | BATTOK  | V <sub>O</sub> = 5.0 V, I <sub>OL</sub> = 3 mA    |                           |                        |                        |      |
|  |  | BATTON  | V <sub>O</sub> = 1.8 V, I <sub>OL</sub> = 500 μA  | 0.2                       |                        |                        |      |
|  |  |   | V <sub>O</sub> = 3.3 V, I <sub>OL</sub> = 3 mA    | 0.4                       |                        |                        |      |
|  |  |   | V <sub>O</sub> = 5.0 V, I <sub>OL</sub> = 5 mA    |                           |                        |                        |      |
|  |  | CEOUT   | V <sub>O</sub> = 2.0 V, I <sub>OL</sub> = 1 mA    | 0.2                       |                        |                        |      |
|  |  |   | V <sub>O</sub> = 3.3 V, I <sub>OL</sub> = 2 mA    | 0.3                       |                        |                        |      |
|  | Enable mode  | V <sub>O</sub> = 5.0 V, I <sub>OL</sub> = 5 mA                                  |   |                           |                        |                        |      |
|  | CEIN = 0 V   |   |   |                           |                        |                        |      |
| V <sub>res</sub> Power-up reset voltage (see Note 2) |  | V <sub>BAT</sub> > 1.1 V OR<br>V <sub>DD</sub> > 1.4 V, I <sub>OL</sub> = 20 μA |   | 0.4                       |                        |                        | V    |
| V <sub>O</sub>                                       | Normal mode  |   | I <sub>O</sub> = 5 mA, V <sub>DD</sub> = 1.8 V    | V <sub>DD</sub> − 50 mV   |                        |                        | V    |
|  |  |   | I <sub>O</sub> = 75 mA, V <sub>DD</sub> = 3.3 V   | V <sub>DD</sub> − 150 mV  |                        |                        |      |
|  |  |   | I <sub>O</sub> = 150 mA, V <sub>DD</sub> = 5 V    | V <sub>DD</sub> − 250 mV  |                        |                        |      |
|  | Battery-backup mode  |   | I <sub>O</sub> = 4 mA, V <sub>BAT</sub> = 1.5 V   | V <sub>BAT</sub> − 50 mV  |                        |                        |      |
|  |  |   | I <sub>O</sub> = 75 mA, V <sub>BAT</sub> = 3.3 V  | V <sub>BAT</sub> − 150 mV |                        |                        |      |
| r <sub>ds(on)</sub>                                  | V <sub>DD</sub> to V <sub>O</sub> on-resistance                |   | V <sub>DD</sub> = 3.3 V                           | 1 2                       |                        |                        | Ω    |
|  | V <sub>BAT</sub> to V <sub>O</sub> on-resistance               |   | V <sub>BAT</sub> = 3.3 V                          | 1 2                       |                        |                        |      |
| V <sub>IT</sub>                                      | Negative-going input threshold voltage (see Notes 3 and 4)     | TPS3600x20  | T <sub>A</sub> = −40°C to 85°C                    | 1.74                      | 1.78                   | 1.82                   | V    |
|  |  | TPS3600x25  |   | 2.17                      | 2.22                   | 2.27                   | V    |
|  |  | TPS3600x30  |   | 2.57                      | 2.63                   | 2.69                   | V    |
|  |  | TPS3600x33  |   | 2.87                      | 2.93                   | 2.99                   | V    |
|  |  | TPS3600x50  |   | 4.31                      | 4.40                   | 4.49                   | V    |
|  |  |   |   |                           |                        |                        |      |
| V(PFI)   |  | PFI   |   | 1.13                      | 1.15                   | 1.17                   |      |
| V(BOK)   |  | TPS3600Dxx  |   | V <sub>IT</sub> + 5.8%    | V <sub>IT</sub> + 7.1% | V <sub>IT</sub> + 8.3% |      |
| V(SWN)   | Battery switch threshold voltage negative-going V <sub>O</sub> |   |   | V <sub>IT</sub> + 1%      | V <sub>IT</sub> + 2%   | V <sub>IT</sub> + 3.2% | V    |

- NOTES: 2. The lowest supply voltage at which  $\overline{\text{RESET}}$  becomes active.  $t_r(V_{DD}) \geq 15 \mu\text{s/V}$ .  
3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1  $\mu\text{F}$ ) should be placed near the supply terminal.  
4. Voltage is sensed at  $V_O$

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electrical characteristics over recommended operating conditions (unless otherwise noted)  
(continued)

| PARAMETER          |                                 | TEST CONDITIONS                                | MIN  | TYP  | MAX | UNIT |
|--------------------|---------------------------------|--|--|------|-----|------|
| V <sub>hys</sub>   | Hysteresis                      | V <sub>IT</sub>                                | 1.65 V < V <sub>IT</sub> < 2.5 V                   | 20   |     | mV   |
|                    |                                 |  | 2.5 V < V <sub>IT</sub> < 3.5 V                    | 40   |     |      |
|                    |                                 |  | 3.5 V < V <sub>IT</sub> < 5.5 V                    | 50   |     |      |
|                    | BATTOK                          | 1.65 V < V <sub>(BOK)</sub> < 2.5 V            | 30   |      |     |      |
|                    |                                 | 2.5 V < V <sub>(BOK)</sub> < 3.5 V             | 60   |      |     |      |
|                    |                                 | 3.5 V < V <sub>(BOK)</sub> < 5.5 V             | 100  |      |     |      |
|                    | PFI                             |  | 12   |      |     |      |
|                    | V <sub>(BSW)</sub>              | V <sub>DD</sub> = 1.8 V                        | 66   |      |     |      |
|                    | V <sub>(SWN)</sub>              | 1.65 V < V <sub>(SWN)</sub> < 2.5 V            | 85   |      |     |      |
|                    |                                 | 2.5 V < V <sub>(SWN)</sub> < 3.5 V             | 100  |      |     |      |
|                    |                                 | 3.5 V < V <sub>(SWN)</sub> < 5.5 V             | 110  |      |     |      |
| I <sub>IH</sub>    | High-level input current        | WDI (see Note 5)                               | WDI = V <sub>DD</sub> = 5 V                        | 150  | μA  |      |
|                    |                                 | MR   | MR = 0.7 × V <sub>DD</sub> , V <sub>DD</sub> = 5 V | −33  |     | −76  |
| I <sub>IL</sub>    | Low-level input current         | WDI (see Note 5)                               | WDI = 0 V, V <sub>DD</sub> = 5 V                   | −150 |     | −255 |
|                    |                                 | MR   | MR = 0 V, V <sub>DD</sub> = 5 V                    | −110 |     |      |
| I <sub>I</sub>     | Input current                   | PFI, MSWITCH                                   | V <sub>I</sub> < V <sub>DD</sub>                   | −25  | 25  | nA   |
| I <sub>OS</sub>    | Short-circuit current           | PFO  | PFO = 0 V, V <sub>DD</sub> = 1.8 V                 | −0.3 | mA  |      |
|                    |                                 |  | PFO = 0 V, V <sub>DD</sub> = 3.3 V                 | −1.1 |     |      |
|                    |                                 |  | PFO = 0 V, V <sub>DD</sub> = 5 V                   | −2.4 |     |      |
| I <sub>DD</sub>    | V <sub>DD</sub> supply current  | V <sub>O</sub> = V <sub>DD</sub>               | 40   | μA   |     |      |
|                    |                                 | V <sub>O</sub> = V <sub>BAT</sub>              | 8  |      |     |      |
| I <sub>(BAT)</sub> | V <sub>BAT</sub> supply current | V <sub>O</sub> = V <sub>DD</sub>               | −0.1   | 0.1  | μA  |      |
|                    |                                 | V <sub>O</sub> = V <sub>BAT</sub>              | 40   |      |     |      |
| I <sub>lkg</sub>   | CEIN leakage current            | Disable mode, V <sub>I</sub> < V <sub>DD</sub> |  | ±1   | μA  |      |
| C <sub>i</sub>     | Input capacitance               | V <sub>I</sub> = 0 V to 5.0 V                  |  | 5    | pF  |      |

NOTE 5: For details on how to optimize current consumption when using WDI, see the detailed description section.



# TPS3600D20, TPS3600D33, TPS3600D50

## BATTERY-BACKUP SUPERVISORS FOR LOW-POWER PROCESSORS

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timing requirements at  $R_L = 1\text{ M}\Omega$ ,  $C_L = 50\text{ pF}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$

| PARAMETER |                        | TEST CONDITIONS  | MIN | TYP | MAX | UNIT          |
|-----------|------------------------|--|-----|-----|-----|---------------|
| $t_w$     | Pulse width            | $V_{IH} = V_{IT} + 0.2\text{ V}$ , $V_{IL} = V_{IT} - 0.2\text{ V}$                            | 6   |     |     | $\mu\text{s}$ |
|           | $\overline{\text{MR}}$ | $V_{DD} > V_{IT} + 0.2\text{ V}$ , $V_{IL} = 0.3 \times V_{DD}$ , $V_{IH} = 0.7 \times V_{DD}$ | 100 |     |     | ns            |
|           | WDI                    |  |     |     |     |               |

switching characteristics at  $R_L = 1\text{ M}\Omega$ ,  $C_L = 50\text{ pF}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$

| PARAMETER           |   | TEST CONDITIONS  | MIN  | TYP | MAX  | UNIT |    |
|---------------------|---|--|------|-----|------|------|----|
| t <sub>d</sub>      | Delay time  | V <sub>DD</sub> ≥ V <sub>IT</sub> + 0.2 V,<br>MR ≥ 0.7 x V <sub>DD</sub> ,<br>See timing diagram | 60   | 100 | 140  | ms   |    |
| t <sub>(tout)</sub> | Watchdog time-out                                     | V <sub>DD</sub> > V <sub>IT</sub> + 0.2 V,<br>See timing diagram                                 | 0.48 | 0.8 | 1.12 | s    |    |
| t <sub>PLH</sub>    | Propagation (delay) time,<br>low-to-high-level output | 50% $\overline{\text{RESET}}$ to 50% $\overline{\text{CEOUT}}$                                   | 15   |     |      | μs   |    |
| t <sub>PHL</sub>    | Propagation (delay) time,<br>high-to-low-level output | V <sub>DD</sub> to $\overline{\text{RESET}}$   | 2    |     |      | 5    | μs |
|                     |   | PFI to $\overline{\text{PFO}}$   | 3    |     |      | 5    | μs |
|                     |   | $\overline{\text{MR}}$ to $\overline{\text{RESET}}$  | 0.1  |     |      | 1    | μs |
|                     |   | 50% CEIN to 50% CEOUT<br>CL = 50 pF only (see Note 6)  | 5    |     |      | 15   | ns |
|                     |   |  | 1.6  |     |      | 5    | ns |
|                     |   |  | 1    |     |      | 3    | ns |
| Transition time     |   | V <sub>DD</sub> to BATTON  | 3    |     |      | μs   |    |

NOTE 6: Assured by design.

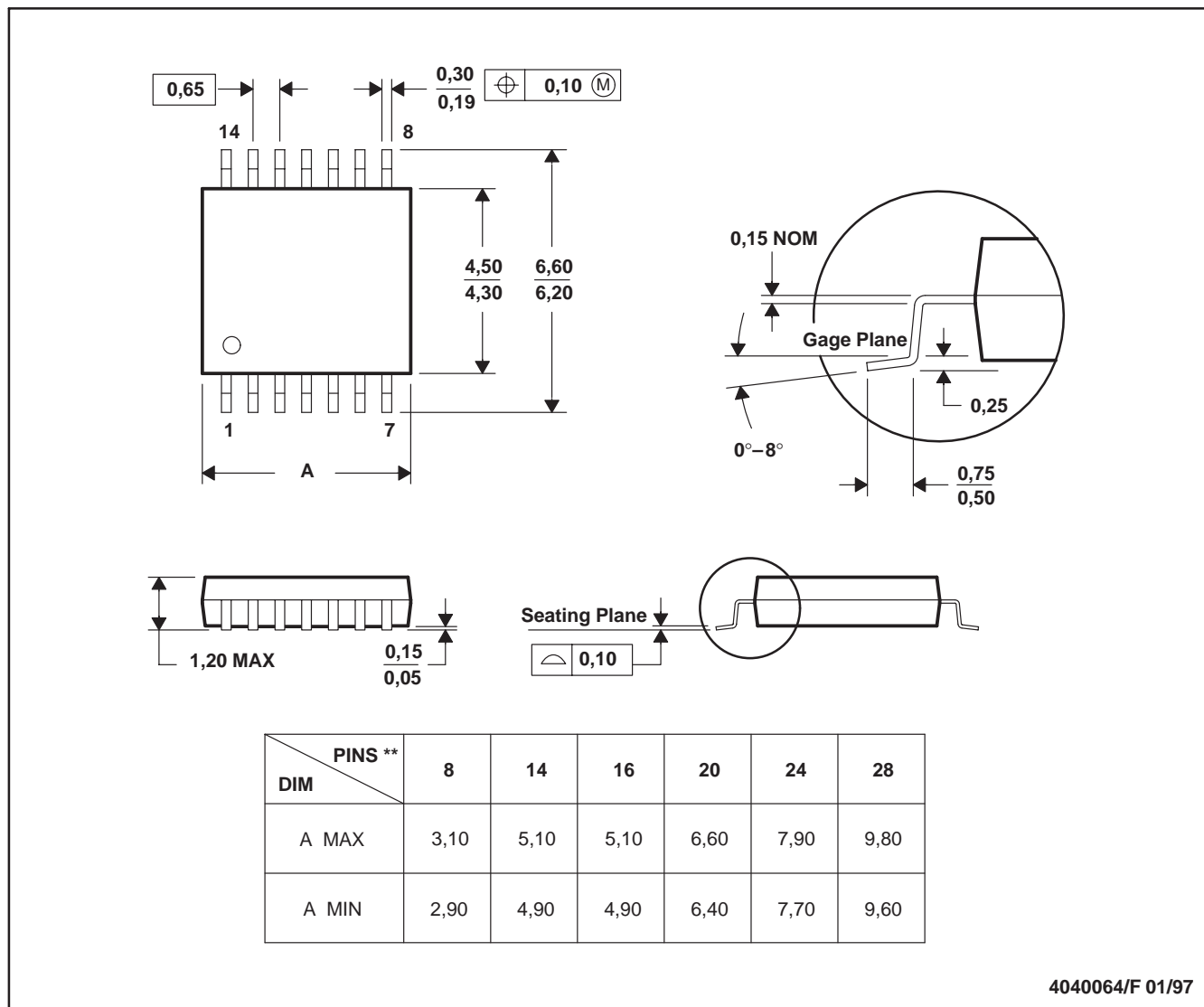


# MECHANICAL DATA

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: C. All linear dimensions are in millimeters.  
D. This drawing is subject to change without notice.  
E. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
F. Falls within JEDEC MO-153

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